

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

<i>In re</i> Application of:	Rajiv Yadav Ranjan	:	Confirmation No.:	2760
Serial No.:	10/776,203	:	Art Unit:	1795
Filed:	2/12/2004	:	Examiner:	Rodney Glenn McDonald
For:	METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS	:		

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE AND REQUEST FOR CONTINUED EXAMINATION

Sir:

In response to the Notice of Appeal filed September 24, 2009 and the Office Action mailed April 24, 2009 for the above captioned patent application, Applicants respectfully request consideration of the following remarks.

Applicants respectfully file a Request for Continued Examination in the above captioned patent application.